NSG1002MX

Product Preview

RF SP3T Switch MMIC

This device is single pole triple throw (SP3T) type RF antenna switch MMIC. It has low insertion loss and high isolation. This is designed for wireless communication applications such as WLAN.

It adopts a small surface mount package and it is also suitable for portable devices such as smart phones.

Features

- Low Insertion Loss
- High Isolation
- Middle Power
- Small-sized Package
- These Devices are Pb–Free, Halogen Free/BFR Free and are RoHS Compliant

Typical Applications

- IEEE802.11 a/b/g/n/ac WLAN, Bluetooth[®] Systems
- LTE
- Wireless Communication Applications

MAXIMUM RATINGS ($T_A = 25^{\circ}C$ unless otherwise noted)

Parameter	Symbol	Value	Unit
Control Voltage	V _{CTL}	6	V
Power Dissipation	P_{D}	150	mW
Storage Temperature Range	T _{stg}	–55 to +150	°C
Operating Temperature Range	T _{opr}	-40 to +105	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

TRUTH TABLE

On Path	V _{CTL1}	V _{CTL2}	V _{CTL3}
IN – OUT1	High	Low	Low
IN – OUT2	Low	High	Low
IN – OUT3	Low	Low Hi	

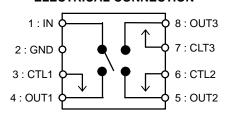


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ELECTRICAL CONNECTION



MARKING DIAGRAM



AA = Specific Device Code

M = Month Code

= Pb–Free Package

(Note: Microdot may be in either location)

ORDERING INFORMATION

Device	Package	Shipping [†]
NSG1002MXT1G	DFN8 (Pb-Free)	3000 / Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

This document contains information on a product under development. ON Semiconductor reserves the right to change or discontinue this product without notice.

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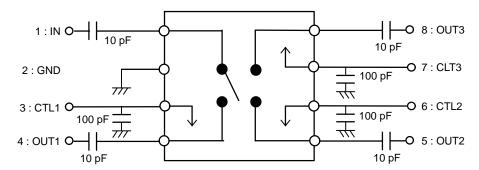
ELECTRICAL CHARACTERISTICS at Ta = 25°C (Note 1) Control Voltage: 0 / +3.0 V, DC Blocking capacitor 10.0 pF

				Value			
Parameter	Symbol	Path	Condition	Min	Тур	Max	Unit
Insertion Loss	IL	IN to OUT1, OUT2, OUT3	f = 2.5 GHz		0.45	0.65	dB
			f = 6.0 GHz		0.65	0.95	
Isolation	ISL	IN to OUT1, OUT2, OUT3	f = 2.5 GHz	23.0	28.0		dB
			f = 6.0 GHz	20.0	25.0		
Return Loss	RL		f = 2.5 GHz		30.0		dB
			f = 6.0 GHz		17.0		
1 dB Loss Compression	Pin 1 dB	IN to OUT1, OUT2, OUT3	f = 2.5 GHz		30.0		dBm
Input Power			f = 6.0 GHz		30.0		
Switching Control Current	I _{CTL}		No Signal		0.1		μΑ

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

1. Pay attention to handling since it is liable to be affected by static electricity due to the high-frequency process adopted.

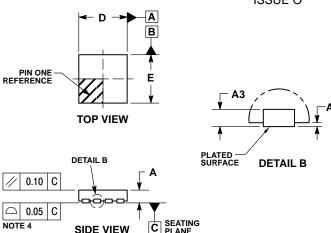
Test Circuit



NSG1002MX

PACKAGE DIMENSIONS

X2DFN8 1.6x1.6, 0.4P CASE 716AE **ISSUE O**



8x L

0.05 M С NOTE 3

Ф

0.10 M C A B

D2

BOTTOM VIEW

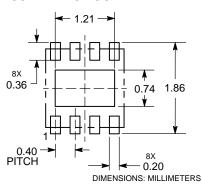
DETAIL A

NOTES

- DIMENSIONING AND TOLERANCING PER ASMF Y14 5M 1994
- ASME 114.3M, 1994. CONTROLLING DIMENSION: MILLIMETERS. DIMENSION 6 APPLIES TO PLATED TERMINAL AND IS MEASURED BETWEEN 0.10 AND
- 0.20 mm FROM THE TERMINAL TIP. COPLANARITY APPLIES TO THE EXPOSED PAD AS WELL AS THE TERMINALS.

	MILLIMETERS			
DIM	MIN	NOM	MAX	
Α	0.30	0.35	0.40	
A1		-	0.05	
А3	0.125 REF			
b	0.13	0.18	0.23	
D	1.50	1.60	1.70	
D2	1.11	1.16	1.21	
Е	1.50	1.60	1.90	
E2	0.64	0.69	0.74	
е	0.40 BSC			
Κ	0.20 REF			
L	0.15	0.25	0.35	

RECOMMENDED SOLDERING FOOTPRINT*



*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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